IPC ASSOCIATION CO	© Copyright 2005.	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.			der both	This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.								
752-21.1		IPC Web Site for Information on IPC-1752 Standard Form Typ http://www.ipc.org/IPC-175x Distribute				Declaration Class * Class 6 - RoHS Yes/No. Homogeneous Mater					ials and Mfc Information			
upplier I	nformation								·					
Company na	nme*	Company u	Company unique ID			Unique ID Authority				Response Date*				
nsemi											2024-05-17			
Contact Nam	ne		Title - Contact			I	Phone - Contact*				Email - Contact*			
Product-Env	v-Stewards		Product Enviro Compliance			1	NA				Product-Env-Stewards@onsemi.com			
uthorized F	Representative*	Title - Representative			I	Phone - Representative*			Email - Representative*					
roduct-Env	v-Stewards	Product Enviro Compliance			1	NA				Product-Env-Stewards@onsemi.com				
R	Requester Item Number	Mfr Item	Mfr Item Number Mfr Item Name NCP451AFCT2G 3A Low Ron Load Switch wi Discharge Path				Effective Date	Version	on Manufacturing Site		We	ight*	UOM	Unit Type
		NCP451.			Switch with A	uto	2024-05-17		M	IY1	1.13	39	mg	Each
Ianufactı	uring Proccess Inform	ation												
Те	Terminal Plating / Grid Array Material Terminal Base Alloy J-STD-020 MSI					Rating	Peak Proce	ess Body Te	mperatur	e Max Time at Peak	Temperature	Numb	er of Reflow Cyc	eles
SnAgCu			CU Alloy	1			260		С	30	seconds	3		
omments														
vel 1 - maxi	imum time at peak tempera	ture during sol	dering is 10-	30 seconds										
or more inf	formation regarding materia	al composition	please refer	to page 3										

RoHS Material Composition Declaration			Declaration Type *	Detail	ed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure it accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its suppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier have not written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies provided as part of that agreement, will be the sole and exclusivesource of the Supplier's liability and the Company's remedies for issues that arise regarding information the Supplier provides											
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the						

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.977	mg	Supplier	Silicon (Si)	7440-21-3		0.977	mg
Protection coat	0.014	mg		Polyimide	proprietary data		0.014	mg
Solder Ball	0.18462	mg	Supplier	Silver (Ag)	7440-22-4		0.0074	mg
			Supplier	Tin (Sn)	7440-31-5		0.1763	mg
			Supplier	Copper (Cu)	7440-50-8		0.0009	mg
UBM Sputter	3.8E-4	mg	Supplier	Titanium (Ti)	7440-32-6		0	mg
			Supplier	Copper (Cu)	7440-50-8		0.0003	mg
Under Bump Metal	0.013	mg	Supplier	Copper (Cu)	7440-50-8		0.013	mg